

#### **N-Channel Enhancement Mode Field Effect Transistor**

## **General Description**

The CMN2302BSM uses advanced trench technology to provide excellent RDS(ON), low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a load switch or in PWM applications.

## **Features**

- RDS(ON)<55mΩ @ VGS=4.5V
- RDS(ON)<75mΩ @ VGS=2.5V
- Simple drive requirement
- Surface mount package

## **Product Summary**

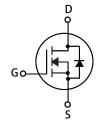
BVDSS	RDSON	ID		
20V	55mΩ	3A		

## **Applications**

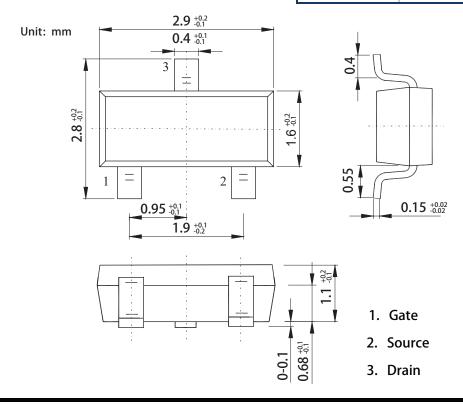
- PWM applications
- Load switch
- Power management
- PA Switch

## **SOT-23-3L Pin Configuration**





Туре	Package	Marking		
CMN2302BSM	SOT-23-3L	BSM		





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## **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units	
$V_{DS}$	Drain-Source Voltage	20	V	
V <sub>GS</sub>	Gate-Source Voltage	±12	V	
I <sub>D</sub> @T <sub>A</sub> =25℃	Continuous Drain Current	3	Α	
I <sub>DM</sub>	Pulsed Drain Current	9	Α	
P <sub>D</sub> @T <sub>A</sub> =25℃	Total Power Dissipation	1.5	W	
T <sub>STG</sub>	Storage Temperature Range -55 to 150		$^{\circ}$ C	
TJ	Operating Junction Temperature Range	150	$^{\circ}$ C	

# Thermal Data

Symbol	Parameter	Тур.	Max.	Unit	
$R_{\theta JA}$	Thermal Resistance Junction-ambient		250	°C/W	

# Electrical Characteristics (T\_J=25 $^{\circ}$ C , unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	20			V
В	Static Drain-Source On-Resistance	$V_{GS}$ =4.5V, $I_D$ =3A			55	mΩ
R <sub>DS(ON)</sub>		$V_{GS}$ =2.5 $V$ , $I_D$ =2 $A$			75	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$ , $I_D=250uA$	0.5		1.0	V
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =20V, V <sub>GS</sub> =0V			1	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	V <sub>GS</sub> = ±12V, V <sub>DS</sub> =0V			±100	nA
gfs	Forward Transconductance	$V_{DS}$ =5 $V$ , $I_{D}$ =3 $A$		5		S
$Q_g$	Total Gate Charge	I <sub>D</sub> =2.5A		3		
$Q_{gs}$	Gate-Source Charge	V <sub>DD</sub> =10V		0.8		nC
$Q_{gd}$	Gate-Drain Charge	V <sub>GS</sub> =4.5V		0.5		
T <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> =10V		6		
Tr	Rise Time	V <sub>GS</sub> =4.5V		3		ne
$T_{d(off)}$	Turn-Off Delay Time	RGEN=6Ω		12		ns
T <sub>f</sub>	Fall Time	I <sub>D</sub> =2.5A		3		
C <sub>iss</sub>	Input Capacitance			350		
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> =10V , V <sub>GS</sub> =0V , f=1MHz		115		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			18		

## **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
V <sub>SD</sub>	Diode Forward Voltage	V <sub>GS</sub> =0V , I <sub>S</sub> =3A			1.2	V

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